74LVC132A Quad 2-input NAND Schmitt trigger Rev. 3 – 7 December 2011

Product data sheet

1. General description

The 74LVC132A provides four 2-input NAND gates with Schmitt trigger inputs. It is capable of transforming slowly-changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_{H} .

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environment.

2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- 5 V tolerant inputs for interfacing with 5 V logic
- CMOS low-power consumption
- Direct interface with TTL levels
- Unlimited input rise and fall times
- Inputs accept voltages up to 5.5 V
- Complies with JEDEC standard JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

3. Applications

- Wave and pulse shapers for highly noisy environments
- Astable multivibrator
- Monostable multivibrator.

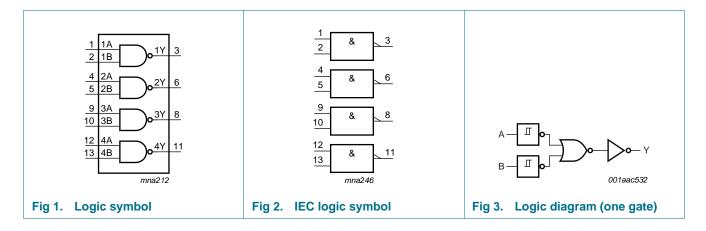


Quad 2-input NAND Schmitt trigger

4. Ordering information

| Table 1. Ordering information | | | | | | | | |
|---------------------------------------|-------------------|----------|--|----------|--|--|--|--|
| Type number | Package | | | | | | | |
| | Temperature range | Name | Description | Version | | | | |
| 74LVC132AD | –40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 | | | | |
| 74LVC132APW | –40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 | | | | |
| 74LVC132ABQ | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm | SOT762-1 | | | | |

5. Functional diagram

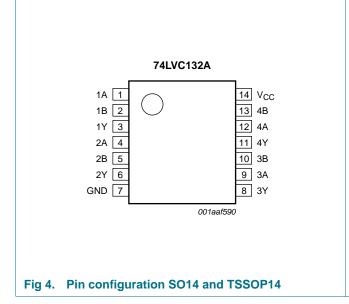


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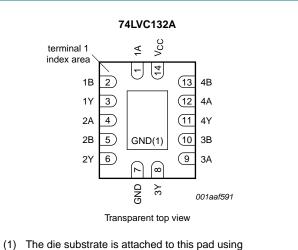
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6. Pinning information

6.1 Pinning



6.2 Pin description



 The die substrate is attached to this pad using conductive die attach material. It can not be used as a supply pin or input.



| Table 2. | Pin description | |
|-----------------|-----------------|----------------|
| Symbol | Pin | Description |
| 1A | 1 | data input |
| 1B | 2 | data input |
| 1Y | 3 | data output |
| 2A | 4 | data input |
| 2B | 5 | data input |
| 2Y | 6 | data output |
| GND | 7 | ground (0 V) |
| 3Y | 8 | data output |
| 3A | 9 | data input |
| 3B | 10 | data input |
| 4Y | 11 | data output |
| 4A | 12 | data input |
| 4B | 13 | data input |
| V _{CC} | 14 | supply voltage |

7. Functional description

Table 3.Function table[1]

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | Н |
| L | Н | Н |
| Н | L | Н |
| Н | Н | L |

[1] H = HIGH voltage level;

L = LOW voltage level.

8. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|--------------------|-----------------------|------|
| V _{CC} | supply voltage | | -0.5 | +6.5 | V |
| VI | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| Vo | output voltage | | <u>[2][3]</u> –0.5 | V _{CC} + 0.5 | V |
| I _{IK} | input clamping current | V ₁ < 0 V | -50 | - | mA |
| I _{OK} | output clamping current | $V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V | - | ±50 | mA |
| lo | output current | $V_{O} = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I _{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$ | <u>[4]</u> _ | 500 | mW |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 3.6 V in normal operation.

[4] For SO14 packages: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For TSSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

9. Recommended operating conditions

| Table 5. | Recommended operating conditions | | | | | | | |
|------------------|----------------------------------|------------|------|-----|-----------------|------|--|--|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit | | |
| V _{CC} | supply voltage | | 1.65 | - | 3.6 | V | | |
| | | functional | 1.2 | - | - | V | | |
| VI | input voltage | | 0 | - | 5.5 | V | | |
| Vo | output voltage | | 0 | - | V _{CC} | V | | |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C | | |

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10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ <mark>[1]</mark> | Max | Unit |
|----------------------|---------------------------|--|---------------|----------------------|------|------|
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| V _{OH} | HIGH-level output voltage | $V_I = V_{T+} \text{ or } V_{T-}$ | | | | |
| | | I_O = $-100~\mu\text{A};~V_{CC}$ = 1.65 V to 3.6 V | $V_{CC}-0.2$ | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | $V_{CC}-0.45$ | - | - | V |
| | | $I_O = -8$ mA; $V_{CC} = 2.3$ V | $V_{CC}-0.5$ | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | $V_{CC}-0.5$ | - | - | V |
| | | $I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | $V_{CC}-0.6$ | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | $V_{CC}-0.8$ | - | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | | |
| | | I_O = 100 $\mu\text{A};V_{CC}$ = 1.65 V to 3.6 V | - | - | 0.2 | V |
| | | $I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.6 | V |
| | | I_{O} = 12 mA; V_{CC} = 2.7 V | - | - | 0.4 | V |
| | | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | V |
| 1 | input leakage current | V_{CC} = 3.6 V; V_{I} = 5.5 V or GND | - | ±0.1 | ±5 | μA |
| l _{cc} | supply current | V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A | - | 0.1 | 10 | μA |
| ∆l _{CC} | additional supply current | per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A | - | 5 | 500 | μA |
| Cı | input capacitance | V_{CC} = 0 V to 3.6 V; V_I = GND to V_{CC} | - | 4.0 | - | pF |
| T _{amb} = – | 40 °C to +125 °C | | | | | |
| V _{он} | HIGH-level output voltage | $V_{I} = V_{T+} \text{ or } V_{T-}$ | | | | |
| | | I_O = $-100~\mu\text{A};~V_{CC}$ = 1.65 V to 3.6 V | $V_{CC}-0.3$ | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | $V_{CC}-0.6$ | - | - | V |
| | | $I_O = -8$ mA; $V_{CC} = 2.3$ V | $V_{CC}-0.65$ | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | $V_{CC}-0.65$ | - | - | V |
| | | $I_{O} = -18$ mA; $V_{CC} = 3.0$ V | $V_{CC}-0.75$ | - | - | V |
| | | $I_{O} = -24$ mA; $V_{CC} = 3.0$ V | $V_{CC}-1$ | - | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | | |
| | | I_O = 100 $\mu A; V_{CC}$ = 1.65 V to 3.6 V | - | - | 0.3 | V |
| | | I_{O} = 4 mA; V_{CC} = 1.65 V | - | - | 0.65 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.8 | V |
| | | I_O = 12 mA; V_{CC} = 2.7 V | - | - | 0.6 | V |
| | | $I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.8 | V |
| I | input leakage current | V_{CC} = 3.6 V; V_{I} = 5.5 V or GND | - | - | ±20 | μΑ |
| lcc | supply current | V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A | - | - | 40 | μA |
| Δl _{CC} | additional supply current | per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A | - | - | 5 | mA |

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

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11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

| Symbol | Parameter | Conditions | Conditions | | –40 °C to +85 °C | | | –40 °C to +125 °C | |
|--------------------|-------------------|--|------------|-----|----------------------|------|-----|-------------------|----|
| | | | | | Typ <mark>[1]</mark> | Max | Min | Max | |
| t _{pd} | propagation delay | nA, nB to nY; see Figure 6 | [2] | | | | | | |
| | | V _{CC} = 1.2 V | | - | 18.0 | - | - | - | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 2.0 | 7.2 | 12.8 | 2.0 | 16.0 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.5 | 4.0 | 7.6 | 1.5 | 9.6 | ns |
| | | $V_{CC} = 2.7 V$ | | 1.5 | 3.8 | 7.6 | 1.5 | 9.6 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 1.5 | 3.4 | 6.4 | 1.5 | 8.0 | ns |
| t _{sk(o)} | output skew time | | [3] | - | - | 1.0 | - | 1.5 | ns |
| C _{PD} | power dissipation | per buffer; $V_I = GND$ to V_{CC} | [4] | | | | | | |
| | capacitance | V_{CC} = 1.65 V to 1.95 V | | - | 10.5 | - | - | - | pF |
| | | V_{CC} = 2.3 V to 2.7 V | | - | 10.8 | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | | - | 11.4 | - | - | - | pF |

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i \times \mathsf{N} + \sum (\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

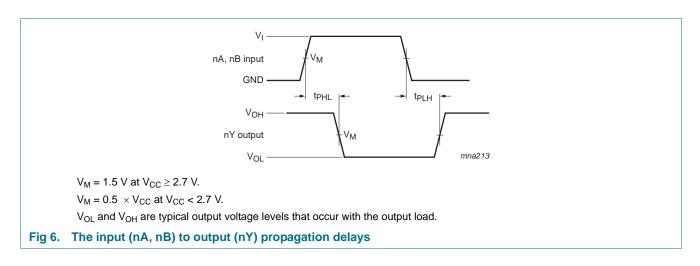
 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

12. Waveforms



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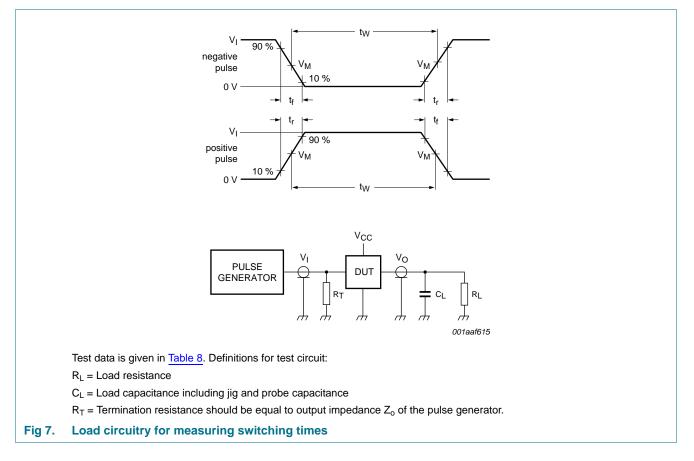


Table 8. Test data

| Supply voltage | Input | | Load | Load | | |
|------------------|-----------------|---------------------------------|-------|-------|--|--|
| | VI | t _r , t _f | CL | RL | | |
| 1.2 V | V _{CC} | \leq 2 ns | 30 pF | 1 kΩ | | |
| 1.65 V to 1.95 V | V _{CC} | \leq 2 ns | 30 pF | 1 kΩ | | |
| 2.3 V to 2.7 V | V _{CC} | \leq 2 ns | 30 pF | 500 Ω | | |
| 2.7 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | | |
| 3.0 V to 3.6 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | | |

Quad 2-input NAND Schmitt trigger

13. Transfer characteristics

Table 9. Transfer characteristics

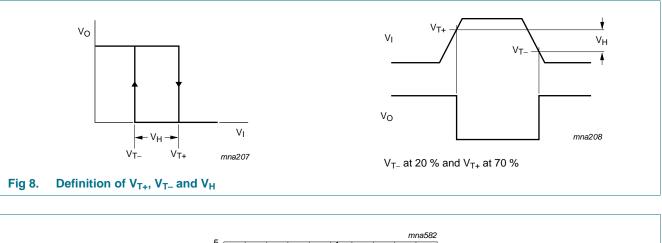
Voltages are referenced to GND (ground = 0 V); see <u>Figure 8</u>.

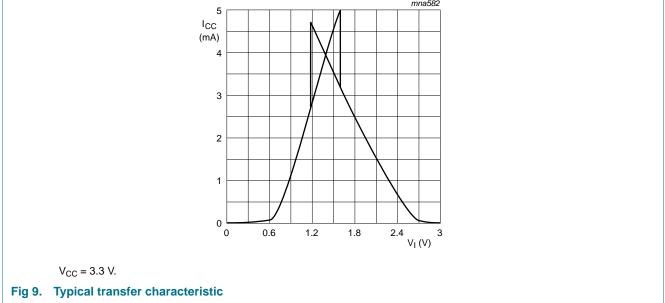
| Symbol | Parameter | Conditions | | –40 °C 1 | to +85 °C | –40 °C to +125 °C | | Unit |
|-----------------|-------------------------------------|--------------------------|------------|----------|-----------|-------------------|------|------|
| | | | | Min | Max | Min | Max | |
| V _{T+} | positive-going | V _{CC} = 1.2 V | | 0.2 | 1.0 | 0.2 | 1.0 | V |
| | threshold voltage | V _{CC} = 1.65 V | | 0.4 | 1.3 | 0.4 | 1.3 | V |
| | | V _{CC} = 1.95 V | | 0.6 | 1.5 | 0.6 | 1.5 | V |
| | | $V_{CC} = 2.3 V$ | | 0.8 | 1.7 | 0.8 | 1.7 | V |
| | | $V_{CC} = 2.5 V$ | | 0.9 | 1.7 | 0.9 | 1.7 | V |
| | | $V_{CC} = 2.7 V$ | | 1.1 | 2 | 1.1 | 2 | V |
| | | $V_{CC} = 3 V$ | | 1.2 | 2 | 1.2 | 2 | V |
| | | V _{CC} = 3.6 V | | 1.2 | 2 | 1.2 | 2 | V |
| V_{T-} | negative-going threshold voltage | V _{CC} = 1.2 V | | 0.12 | 0.75 | 0.12 | 0.75 | V |
| | | V _{CC} = 1.65 V | | 0.15 | 0.85 | 0.15 | 0.85 | V |
| | | V _{CC} = 1.95 V | | 0.25 | 0.95 | 0.25 | 0.95 | V |
| | | $V_{CC} = 2.3 V$ | | 0.4 | 1.1 | 0.4 | 1.1 | V |
| | | $V_{CC} = 2.5 V$ | | 0.4 | 1.2 | 0.4 | 1.2 | V |
| | | $V_{CC} = 2.7 V$ | | 0.8 | 1.4 | 0.8 | 1.4 | V |
| | | $V_{CC} = 3 V$ | | 0.8 | 1.5 | 0.8 | 1.5 | V |
| | | V _{CC} = 3.6 V | | 0.8 | 1.5 | 0.8 | 1.5 | V |
| V _H | hysteresis voltage | V _{CC} = 1.2 V | | 0.1 | 1.0 | 0.1 | 1.0 | V |
| | $(V_{T+} - V_{T-})$ | V _{CC} = 1.65 V | | 0.2 | 1.15 | 0.2 | 1.15 | V |
| | | V _{CC} = 1.95 V | | 0.2 | 1.25 | 0.2 | 1.25 | V |
| | | $V_{CC} = 2.3 V$ | | 0.3 | 1.3 | 0.3 | 1.3 | V |
| | | V _{CC} = 2.5 V | | 0.3 | 1.3 | 0.3 | 1.3 | V |
| | | V _{CC} = 2.7 V | | 0.3 | 1.1 | 0.3 | 1.1 | V |
| | | $V_{CC} = 3 V$ | | 0.3 | 1.2 | 0.3 | 1.2 | V |
| | | V _{CC} = 3.6 V | <u>[1]</u> | 0.3 | 1.2 | 0.3 | 1.2 | V |

[1] Typical transfer characteristic is displayed in Figure 9.

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14. Waveforms transfer characteristics





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15. Package outline

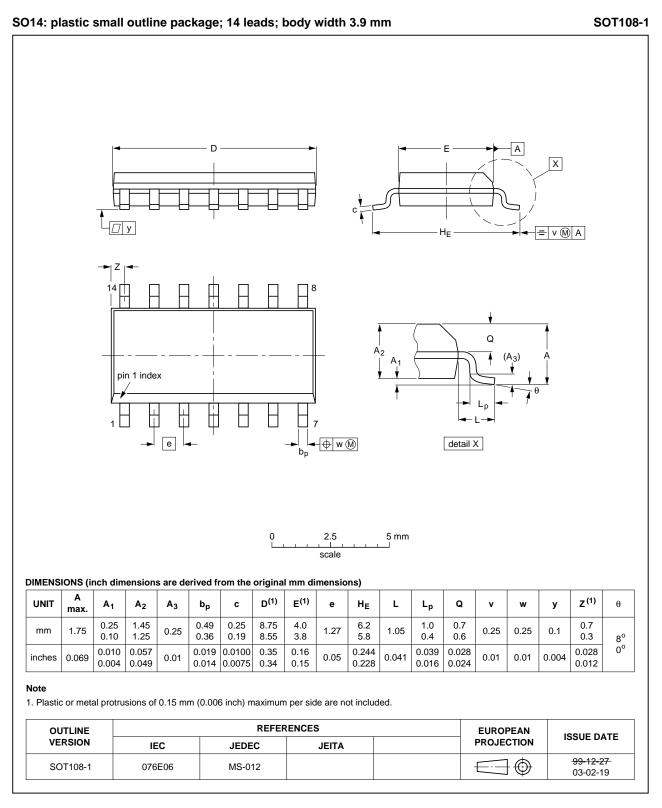


Fig 10. Package outline SOT108-1 (SO14)

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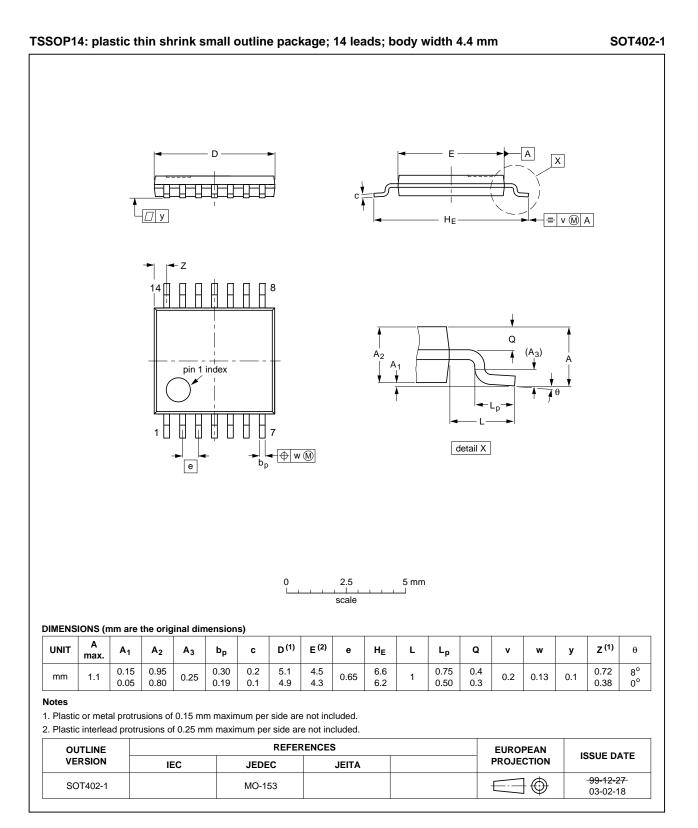
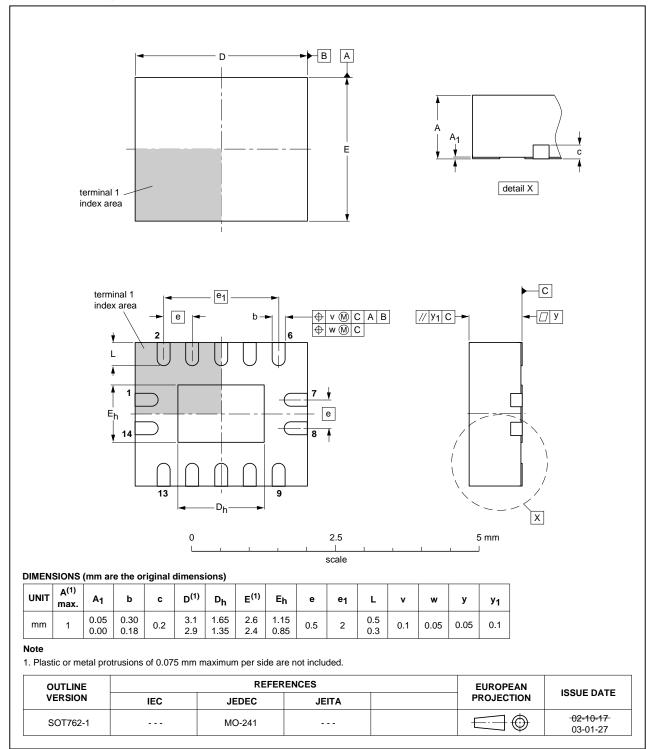


Fig 11. Package outline SOT402-1 (TSSOP14)



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 12. Package outline SOT762-1 (DHVQFN14)

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Quad 2-input NAND Schmitt trigger

16. Abbreviations

| Table 10. | 0. Abbreviations | | | | |
|-----------|---|--|--|--|--|
| Acronym | Description | | | | |
| CDM | Charged Device Model | | | | |
| CMOS | Complementary Metal Oxide Semiconductor | | | | |
| DUT | Device Under Test | | | | |
| ESD | ElectroStatic Discharge | | | | |
| HBM | Human Body Model | | | | |
| MM | Machine Model | | | | |
| TTL | Transistor-Transistor Logic | | | | |

17. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---------------------------------|--------------------|---------------|---------------|
| 74LVC132A v.3 | 20111207 | Product data sheet | - | 74LVC132A v.2 |
| Modifications: | Legal pages | s updated. | | |
| 74LVC132A v.2 | 20110829 | Product data sheet | - | 74LVC132A v.1 |
| 74LVC132A v.1 | 20061215 | Product data sheet | - | - |

Quad 2-input NAND Schmitt trigger

18. Legal information

18.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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